



# PBSS5350T

50 V, 3 A PNP low V<sub>CEsat</sub> transistor

10 May 2022

Product data sheet

## 1. General description

PNP low V<sub>CEsat</sub> transistor in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

NPN complement: PBSS4350T

## 2. Features and benefits

- Low collector-emitter saturation voltage V<sub>CEsat</sub> and corresponding low R<sub>CEsat</sub>
- High collector current capability
- High collector current gain
- Improved efficiency due to reduced heat generation
- AEC-Q101 qualified

## 3. Applications

- Power management applications
- Low and medium power DC/DC converters
- Supply line switching
- Battery chargers
- Linear voltage regulation with low voltage drop-out (LDO)

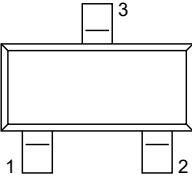
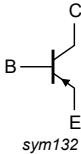
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	-50	V
I <sub>C</sub>	collector current		-	-	-2	A
I <sub>CRM</sub>	repetitive peak collector current	$\delta \leq 0.25$ ; Operated under pulsed conditions; $t_p \leq 100$ ms	-	-	-3	A
R <sub>CEsat</sub>	collector-emitter saturation resistance	I <sub>C</sub> = -2 A; I <sub>B</sub> = -200 mA; pulsed; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; T <sub>amb</sub> = 25 °C	-	90	135	m $\Omega$

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 SOT23	 sym132
2	E	emitter		
3	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">PBSS5350T</a>	SOT23	plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	<a href="#">SOT23</a>

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PBSS5350T	ZD %

[1] % = placeholder for manufacturing site code

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter		-	-50	V
$V_{CEO}$	collector-emitter voltage	open base		-	-50	V
$V_{EBO}$	emitter-base voltage	open collector		-	-5	V
$I_C$	collector current			-	-2	A
$I_{CRM}$	repetitive peak collector current	$\delta \leq 0.25$ ; Operated under pulsed conditions; $t_p \leq 100$ ms		-	-3	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1$ ms		-	-5	A
$I_B$	base current			-	-0.5	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25$ °C	[1]	-	300	mW
			[2]	-	480	mW
			[3]	-	540	mW
			[4]	-	500	mW
			[1] [5]	-	1.2	W
$T_j$	junction temperature			-	150	°C
$T_{amb}$	ambient temperature			-65	150	°C
$T_{stg}$	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector  $1\text{ cm}^2$ .

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector  $6\text{ cm}^2$ .

[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[5] Operated under pulsed conditions: pulse width  $t_p \leq 100$  ms; duty cycle  $\delta \leq 0.25$ .

## 9. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	417	K/W
			[2]	-	-	260	K/W
			[3]	-	-	230	K/W
			[4]	-	-	250	K/W
			[1] [5]	-	-	104	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	75	-	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector  $1\text{ cm}^2$ .

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector  $6\text{ cm}^2$ .

[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[5] Operated under pulsed conditions: pulse width  $t_p \leq 100$  ms; duty cycle  $\delta \leq 0.25$ .

## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = -100 \mu A$ ; $I_E = 0 A$ ; $T_{amb} = 25^\circ C$	-50	-	-	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = -10 mA$ ; $I_B = 0 A$ ; $T_{amb} = 25^\circ C$	-50	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage (collector open)	$I_E = -100 \mu A$ ; $I_C = 0 A$ ; $T_{amb} = 25^\circ C$	-6	-	-	V
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -50 V$ ; $I_E = 0 A$ ; $T_{amb} = 25^\circ C$	-	-	-100	nA
		$V_{CB} = -50 V$ ; $I_E = 0 A$ ; $T_j = 150^\circ C$	-	-	-50	$\mu A$
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -5 V$ ; $I_C = 0 A$ ; $T_{amb} = 25^\circ C$	-	-	-100	nA
$h_{FE}$	DC current gain	$V_{CE} = -2 V$ ; $I_C = -100 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	200	-	-	
		$V_{CE} = -2 V$ ; $I_C = -500 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	200	-	-	
		$V_{CE} = -2 V$ ; $I_C = -1 A$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	200	-	-	
		$V_{CE} = -2 V$ ; $I_C = -2 A$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	130	-	-	
		$V_{CE} = -2 V$ ; $I_C = -3 A$ ; pulsed; $t_p \leq 300 \mu s$ ; $T_{amb} = 25^\circ C$	80	-	-	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -500 mA$ ; $I_B = -50 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta = 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-90	mV
		$I_C = -1 A$ ; $I_B = -50 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-180	mV
		$I_C = -2 A$ ; $I_B = -100 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-320	mV
		$I_C = -2 A$ ; $I_B = -200 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-270	mV
		$I_C = -3 A$ ; $I_B = -300 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-390	mV
$R_{CEsat}$	collector-emitter saturation resistance	$I_C = -2 A$ ; $I_B = -200 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	90	135	m $\Omega$
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -2 A$ ; $I_B = -100 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-1.1	V
		$I_C = -3 A$ ; $I_B = -300 mA$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-1.2	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = -2 V$ ; $I_C = -1 A$ ; pulsed; $t_p \leq 300 \mu s$ ; $\delta \leq 0.02$ ; $T_{amb} = 25^\circ C$	-	-	-1.2	V
$f_T$	transition frequency	$V_{CE} = -5 V$ ; $I_C = -100 mA$ ; $f = 100 MHz$ ; $T_{amb} = 25^\circ C$	100	-	-	MHz
$C_c$	collector capacitance	$V_{CB} = -10 V$ ; $I_E = 0 A$ ; $i_e = 0 A$ ; $f = 1 MHz$ ; $T_{amb} = 25^\circ C$	-	-	35	pF

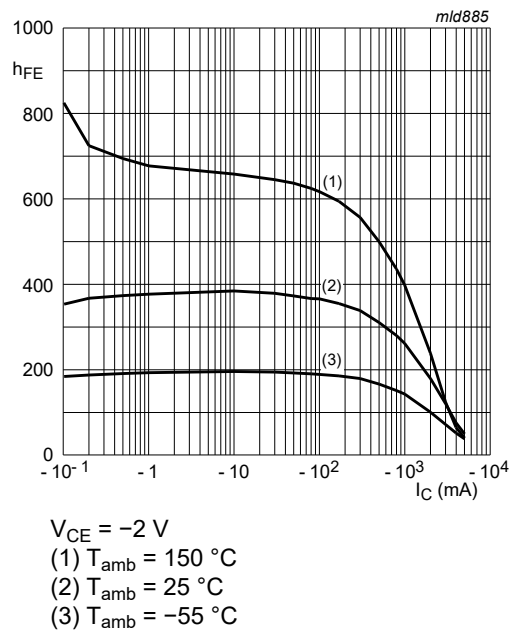


Fig. 1. DC current gain as a function of collector current; typical values

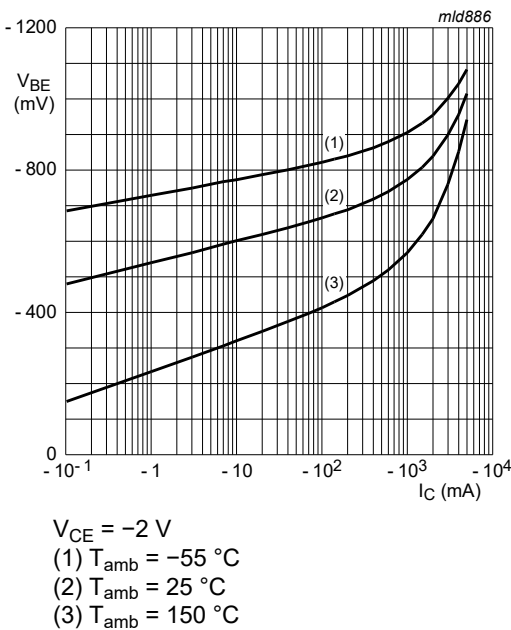


Fig. 2. Base-emitter voltage as a function of collector current; typical values

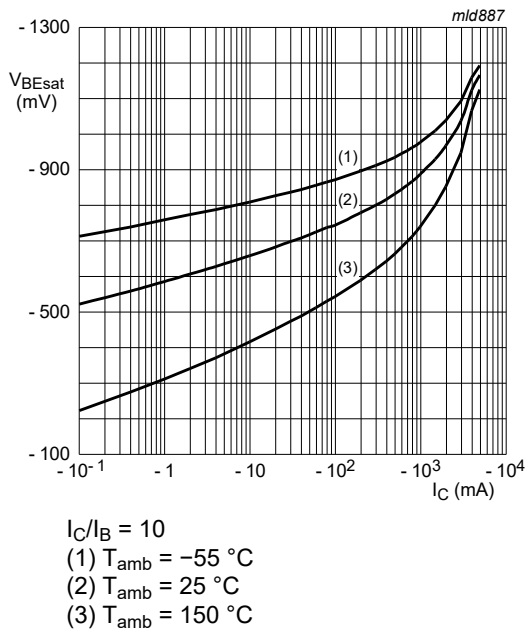


Fig. 3. Base-emitter saturation voltage as a function of collector current; typical values

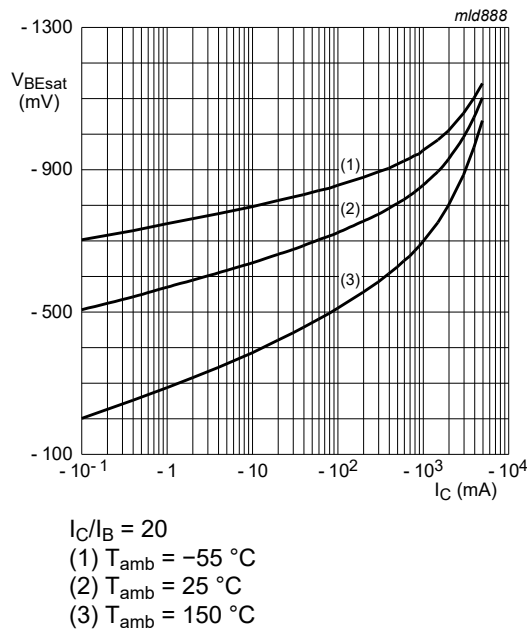


Fig. 4. Base-emitter saturation voltage as a function of collector current; typical values

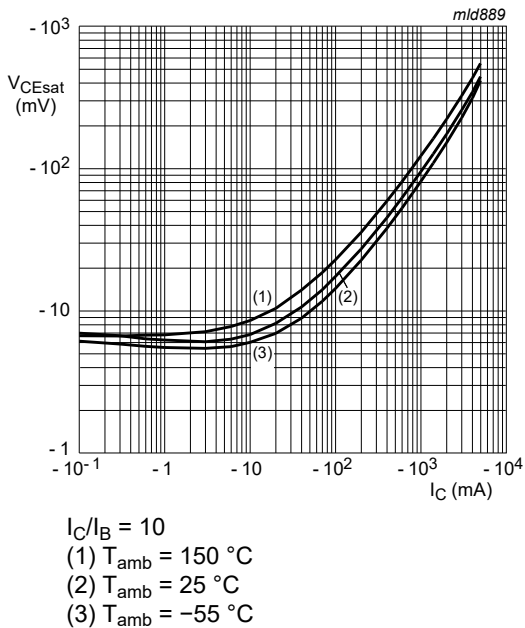


Fig. 5. Collector-emitter saturation voltage as a function of collector current; typical values

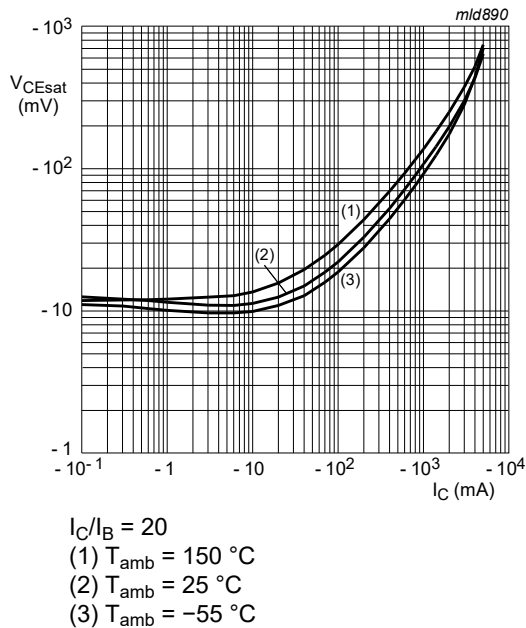


Fig. 6. Collector-emitter saturation voltage as a function of collector current; typical values

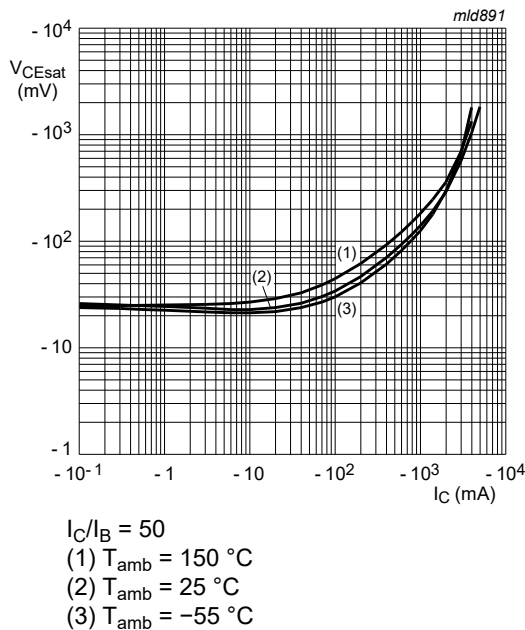


Fig. 7. Collector-emitter saturation voltage as a function of collector current; typical values

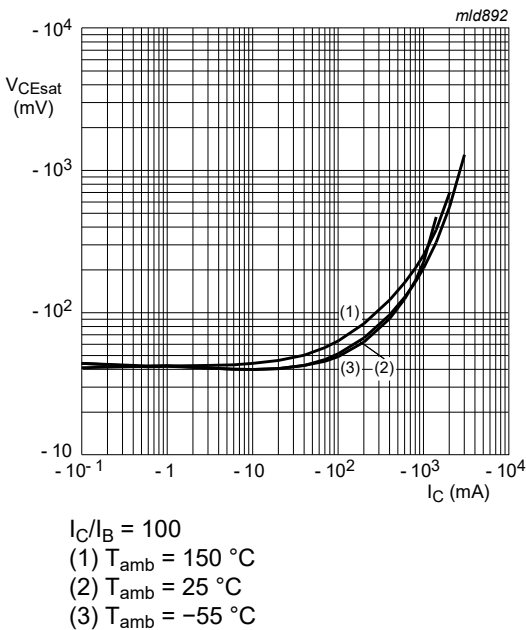
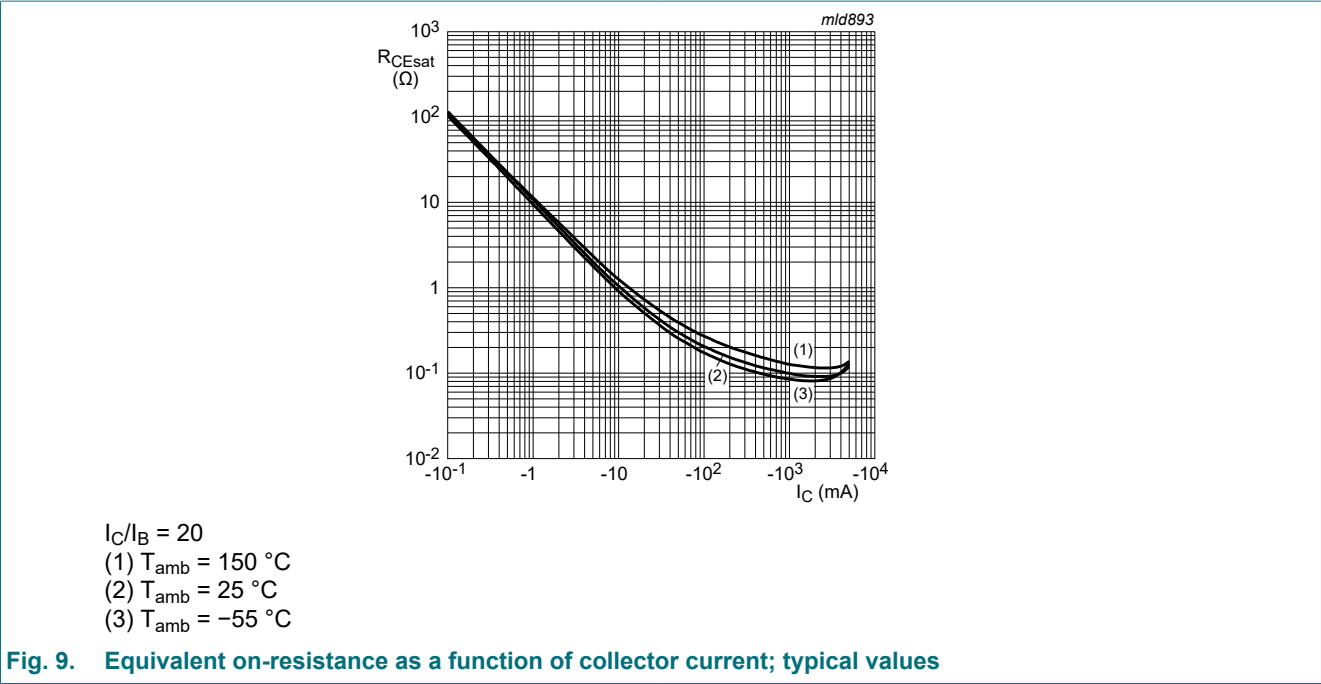


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

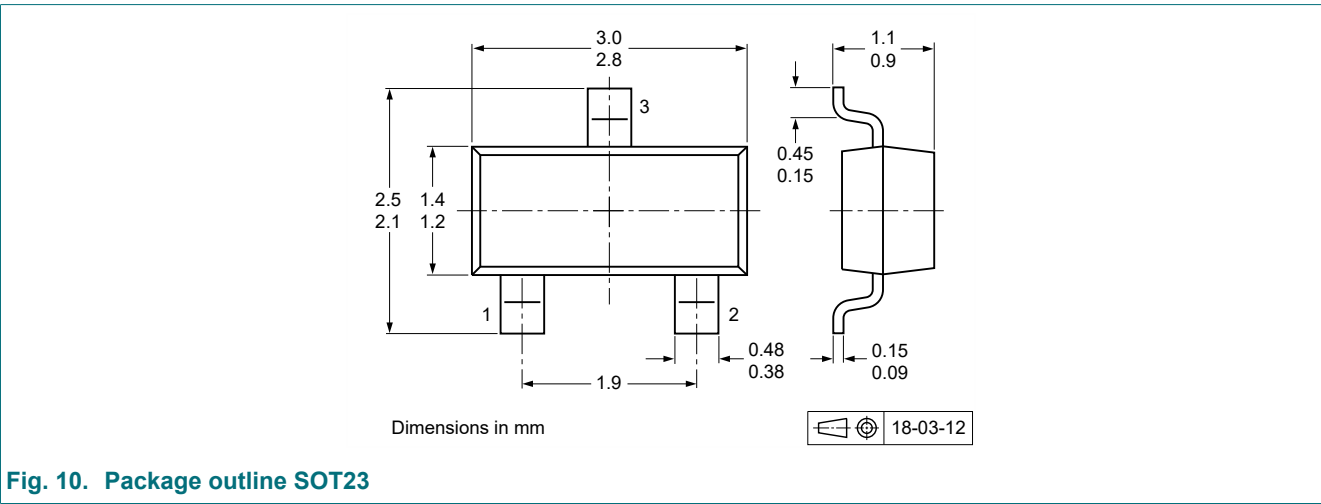


11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering

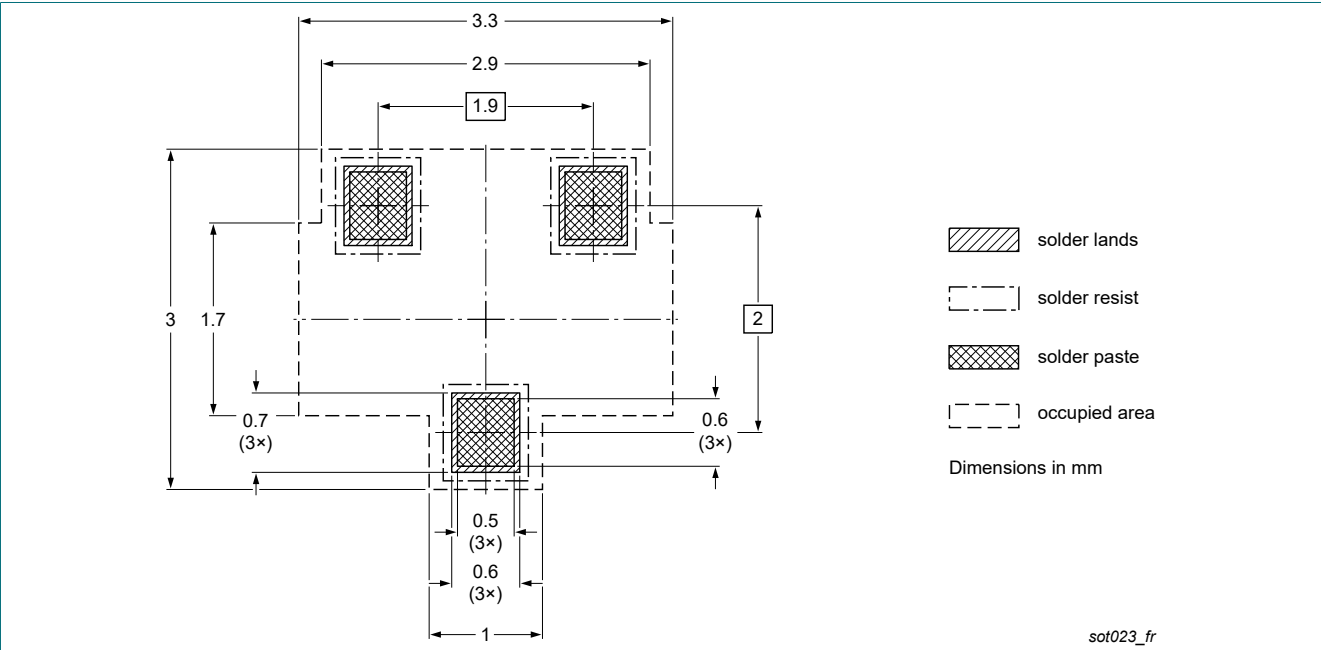


Fig. 11. Reflow soldering footprint for SOT23

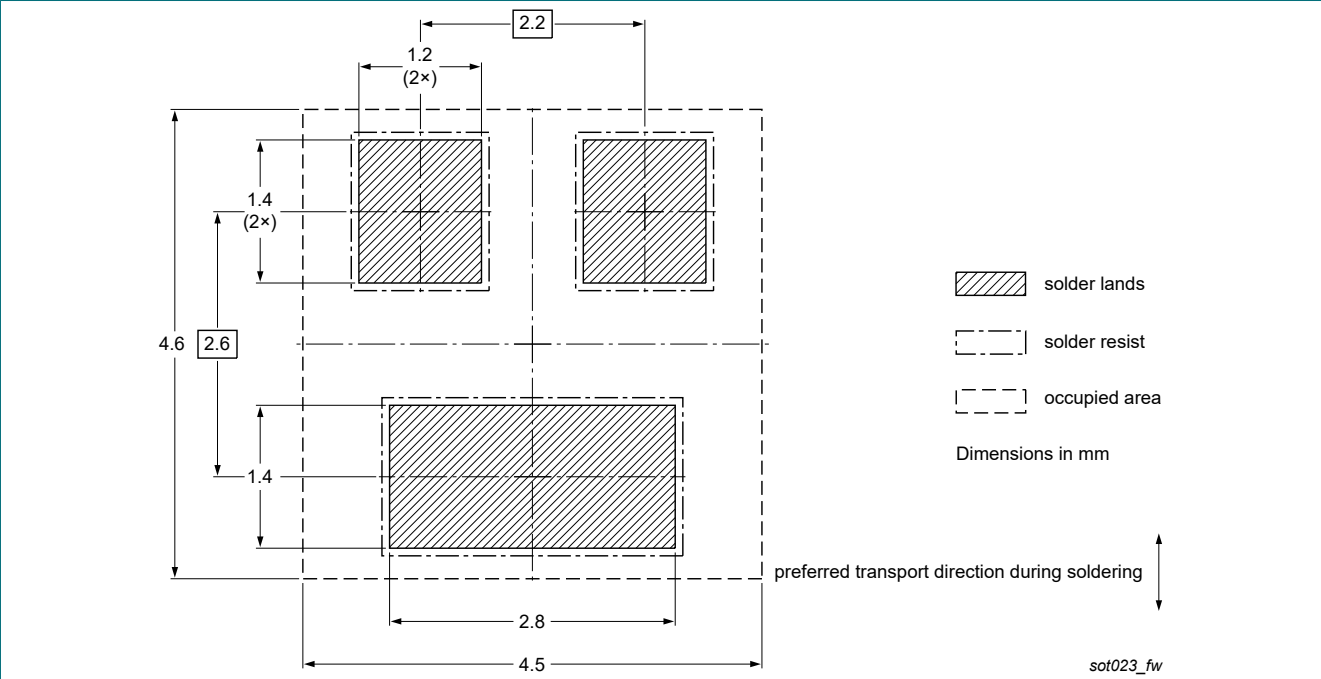


Fig. 12. Wave soldering footprint for SOT23



## 14. Revision history

**Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS5350T v.3	20220510	Product data sheet	-	PBSS5350T v.2
Modifications:	<ul style="list-style-type: none"><li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li><li>Legal texts have been adapted to the new company name where appropriate.</li></ul>			
PBSS5350T v.2	20040113	Product data sheet	-	PBSS5350T v.1
PBSS5350T v.1	20020808	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 10 May 2022